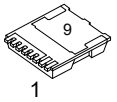
UTG25N120LND3

Insulated Gate Bipolar Transistor

1200V TRENCH GATE FIELD-STOP IGBT



TOLL-8B

■ DESCRIPTION

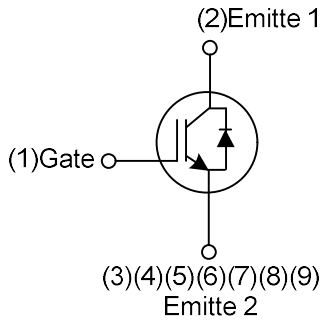
The UTC **UTG25N120LND3** is an Trench Field-Stop Insulated Gate Bipolar Transistor. it uses UTC's advanced technology to provide customers with high switching speed, low saturation voltage and low switching loss, etc.

The UTC **UTG25N120LND3** is suitable for the resonant or soft switching applications.

■ FEATURES

* High switching speed
* High avalanche ruggedness
* Low saturation voltage: $V_{CE(SAT).Typ.}$=1.6V @ I_C=25A, V_{GE}=15V (T_C =25°C)

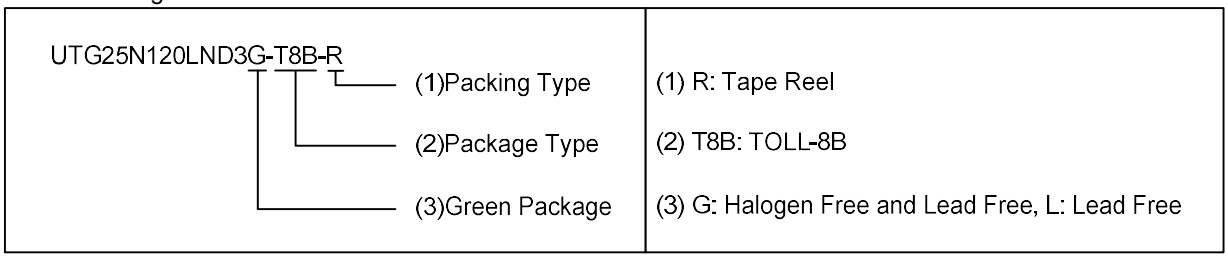
■ SYMBOL



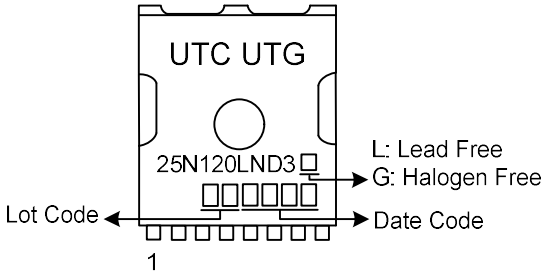
■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment									Packing
Lead Free	Halogen Free		1	2	3	4	5	6	7	8	9	
UTG25N120LND3L-T8B-R	UTG25N120LND3G-T8B-R	TOLL-8B	G	E1	E2	E2	E2	E2	E2	E2	E2	Tape Reel

Note: Pin Assignment: G: Gate E: Emitter



■ MARKING


UTC UTG
25N120LND3
L: Lead Free
G: Halogen Free
Lot Code
Date Code
1

■ ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Collector-Emitter Voltage		V_{CES}	1200	V
Gate-Emitter Voltage		V_{GES}	±20	V
Transient Gate-emitter voltage (t_P < 5 ms)			±25	V
Continuous Collector Current	T_C=25°C	I_C	50	A
	T_C=100°C		25	A
Collector Current Pulsed (Note 1)		I_{CM}	100	A
Diode Forward Current	T_C=25°C	I_F	50	A
	T_C=100°C		25	A
Power Dissipation (T_C=25°C)		P_D	170	W
Operating Junction Temperature		T_J	-40 ~ +150	°C
Storage Temperature Range		T_{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are stress ratings only and functional device operation is not implied. Absolute maximum ratings are those values beyond which the device could be permanently damaged.
2. Pulse width limited by maximum junction temperature.

■ THERMAL DATA

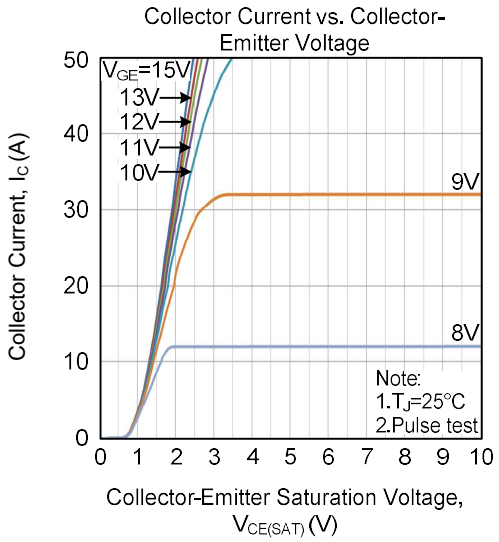
PARAMETER	SYMBOL	RATING	UNIT
Junction to Case	θ_{JC}	0.73	°C/W

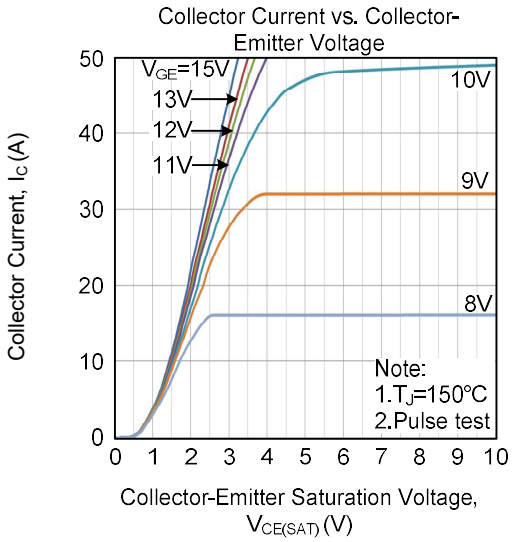
Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

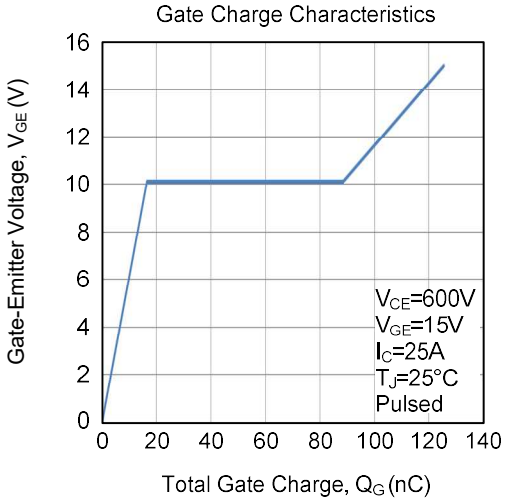
■ ELECTRICAL CHARACTERISTICS (T_C = 25°C, unless otherwise specified)

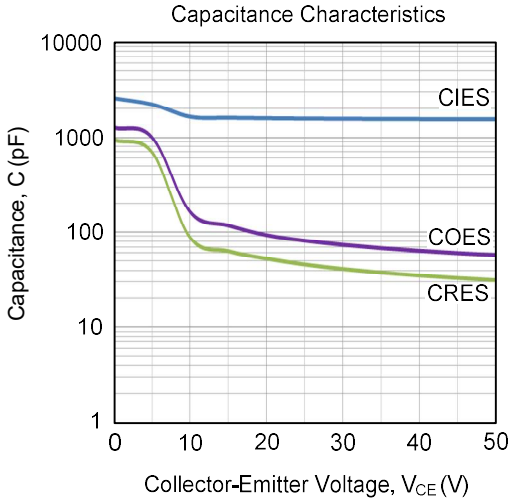
PARAMETER	SYMBOL	TEST CONDITIONS		MIN	TYP	MAX	UNIT
Off Characteristics							
Collector-Emitter Breakdown Voltage	BV_{CES}			1200			V
Collector Cut-Off Current	I_{CES}	V_{CE}=1200V, V_{GE}=0V				5	μA
G-E Leakage Current	I_{GES}	V_{CE}=0V, V_{GE}=±20V				±400	nA
On Characteristics							
Gate to Emitter Threshold Voltage	$V_{GE(TH)}$	I_C=250μA, V_{CE}=V_{GE}		4.5		7.5	V
Collector to Emitter Saturation Voltage	$V_{CE(SAT)}$	I_C=25A, V_{GE}=15V	T_C=25°C		1.6	2.1	V
			T_C=125°C		2.0		V
Dynamic Characteristics							
Input Capacitance	C_{IES}	V_{CE}=25V, V_{GE}=0V, f=1MHz			1.6		nF
Output Capacitance	C_{OES}				75		pF
Reverse Transfer Capacitance	C_{RES}				40		pF
Switching Characteristics							
Total Gate Charge	Q_G	V_{CE}=600V, I_C=25A, V_{GE}=15V			126		nC
Gate-Emitter Charge	Q_{GE}				16		nC
Gate-Collector Charge	Q_{GC}				73		nC
Turn-On Delay Time	$t_{DON)}$	V_{CC}=600V, I_C=25A, R_G=5Ω, V_{GE}=0~15V, L=500μH			12		ns
Rise Time	t_R				29		ns
Turn-Off Delay Time	$t_{DOFF)}$				134		ns
Fall Time	t_F				267		ns
Turn-On Switching Loss	E_{ON}				1.7		mJ
Turn-Off Switching Loss	E_{OFF}				2.1		mJ
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Forward Voltage Drop	V_F	I_F=25A				2.7	V
Reverse Recovery Time	t_{rr}	I_F=25A, dI/dt=100A/μS, V_{CC}=600V			46		ns
Reverse Recovery Charge	Q_{rr}				938		μC

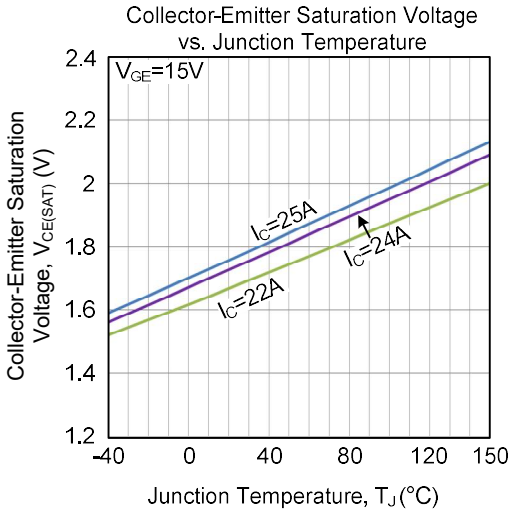
■ TYPICAL CHARACTERISTICS

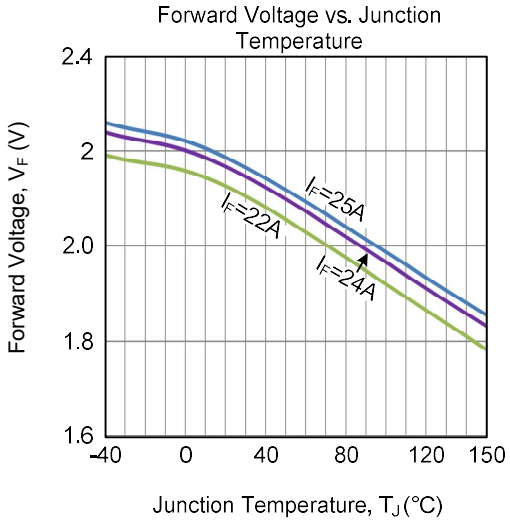






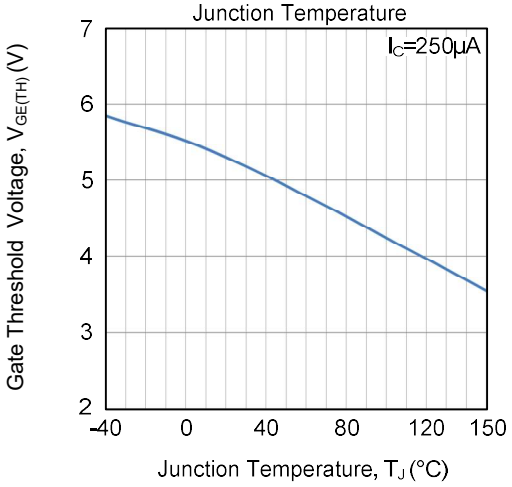




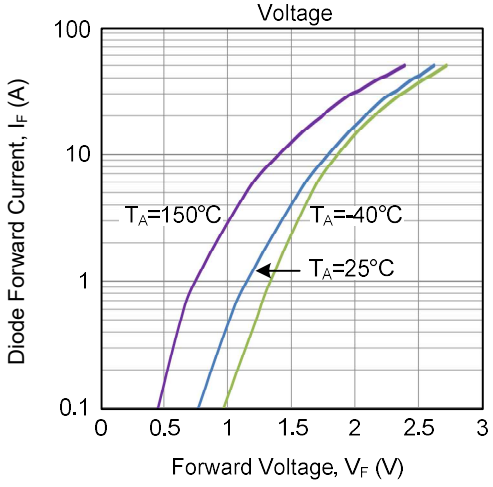


■ TYPICAL CHARACTERISTICS (Cont.)

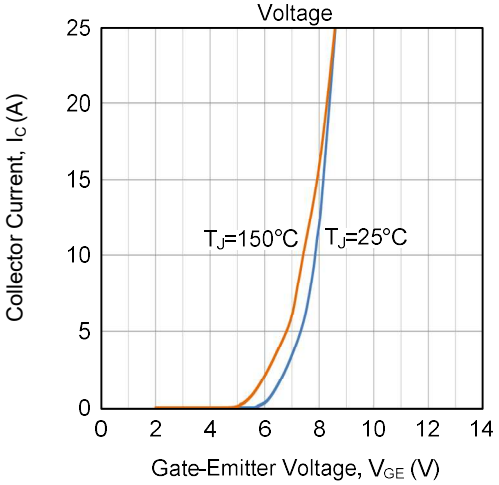
Gate Threshold Voltage vs. Junction Temperature



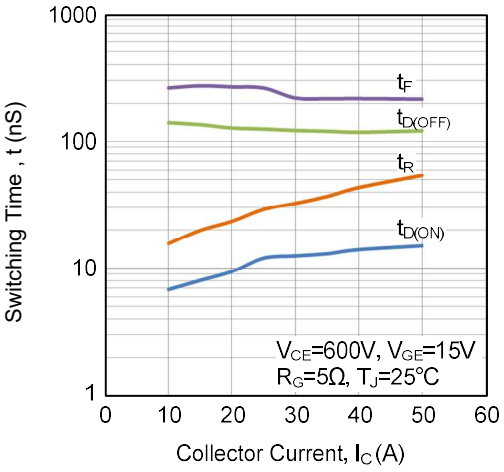
Diode Forward Current vs. Forward Voltage



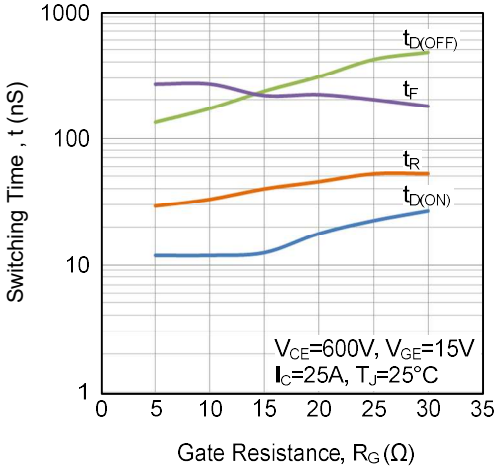
Collector Current vs. Gate-Emitter Voltage



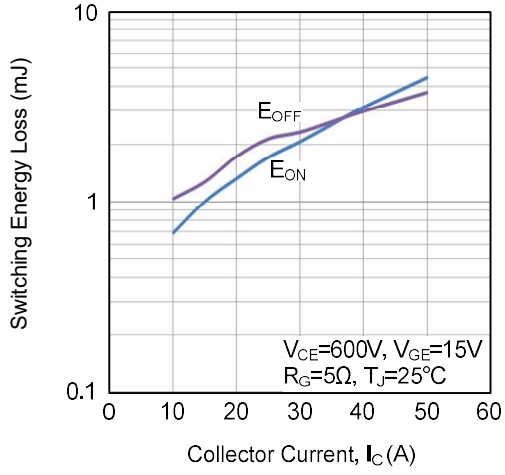
Switching Time vs. Collector Current



Switching Time vs. Gate Resistance



Switching Loss vs. Collector Current



■ TYPICAL CHARACTERISTICS (Cont.)